

RCX080N25

Nch 250V 8A Power MOSFET

V_{DSS}	250V
$R_{DS(on)}(Max.)$	600 m Ω
I _D	8A
P_D	35W

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating; RoHS compliant
- 6) 100% Avalanche tested

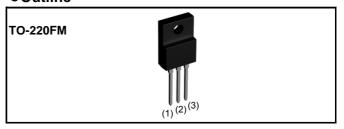
Application

Switching Power Supply

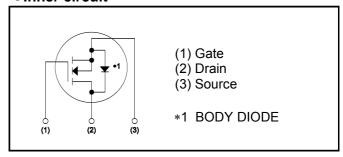
Automotive Motor Drive

Automotive Solenoid Drive

Outline



•Inner circuit



Packaging specifications

}	Packaging	Bulk
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Quantity (pcs)	500
	Taping code	-
	Marking	RCX080N25

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	$V_{ m DSS}$	250	V	
Continuous drain current	T _c = 25°C	I _D ^{*1}	8	А
	T _c = 100°C	I _D *1	±4.3	А
Pulsed drain current	I _{D,pulse} *2	±32	А	
Gate - Source voltage	V_{GSS}	±30	V	
Avalanche energy, single pulse	E _{AS} *3	4.66	mJ	
Avalanche current	I _{AS} *3	4	А	
$T_c = 25^{\circ}C$		P_{D}	35	W
Power dissipation $T_a = 25^{\circ}C^{*4}$		P_{D}	2.23	W
Junction temperature	T _j	150	°C	
Range of storage temperature	T _{stg}	-55 to +150	°C	

●Thermal resistance

Parameter	Symbol	Values			Unit
- Farameter	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	R_{thJC}	-	-	3.57	°C/W
Thermal resistance, junction - ambient *4	R_{thJA}	-	-	56	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V$, $I_D = 1mA$	250	ı	ı	V	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 250V, V_{GS} = 0V$ $T_j = 25^{\circ}C$	ı	ı	10	μА	
Gate - Source leakage current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	ı	I	±100	nA	
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = 10V, I_D = 1mA	3.0	-	5.0	V	
		$V_{GS} = 10V, I_D = 4.0A$	-	460	600		
Static drain - source on - state resistance	R _{DS(on)} *5	$V_{GS} = 10V, I_D = 4.0A$ $T_j = 125^{\circ}C$	-	910	1280	mΩ	
Forward transfer admittance	g _{fs}	$V_{DS} = 10V, I_{D} = 4.0A$	2.2	4.4	-	S	

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input capacitance	C _{iss}	V _{GS} = 0V	-	840	-	
Output capacitance	C _{oss}	V _{DS} = 25V	-	50	-	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	25	-	
Turn - on delay time	t _{d(on)} *5	V _{DD} ≃ 125V, V _{GS} = 10V	-	22	-	
Rise time	t _r *5	I _D = 4.0A	-	28	-	no
Turn - off delay time	t _{d(off)} *5	$R_L = 31.25\Omega$	-	28	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	14	-	

•Gate Charge characteristics ($T_a = 25^{\circ}C$)

Parameter	Cumbal	Conditions	Values			Unit
raiainetei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Total gate charge	Q_g^{*5}	V _{DD} ≃ 125V	-	15	-	
Gate - Source charge	Q _{gs} *5	I _D = 8.0A	-	6.25	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	5.5	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 125V, I_D = 8A$	-	8.4	-	V

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Darameter	Cymbol	Conditions	Values			Linit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Continuous source current	I _S *1	T _c = 25°C	-	1	8	Α
Pulsed source current	I _{SM} *2	1 _c = 23 C	-	-	32	Α
Forward voltage	V _{SD} *5	$V_{GS} = 0V, I_S = 8.0A$	-	-	1.5	V
Reverse recovery time	t _{rr} *5	I _S = 4.0A	-	95	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/μs	-	330	-	nC

^{*1} Limited only by maximum temperature allowed.

^{*2} Pw \leq 10 μ s, Duty cycle \leq 1%

^{*3} L \simeq 500 μ H, V_{DD} = 50V, Rg = 25 Ω , starting T $_{j}$ = 25 $^{\circ}$ C

^{*4} Mounted on a epoxy PCB FR4 (20mm × 30mm × 0.8mm)

^{*5} Pulsed

Fig.1 Power Dissipation Derating Curve

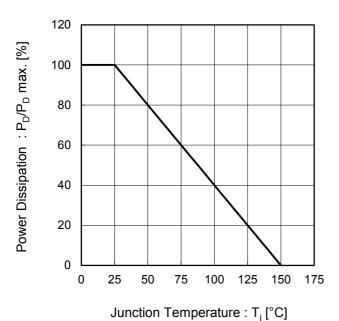
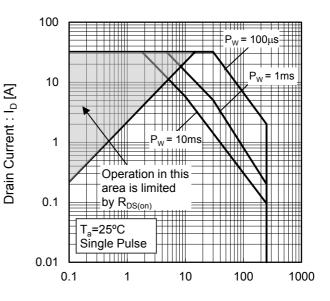
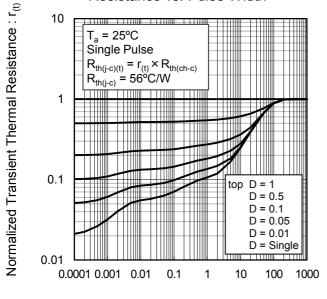


Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



Pulse Width: Pw [s]

Fig.4 Avalanche Current vs Inductive Load

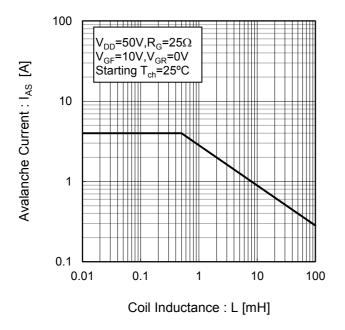
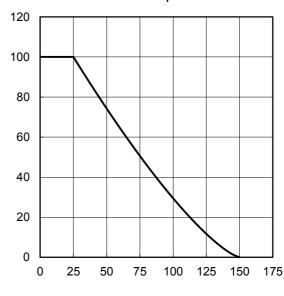


Fig.5 Avalanche Energy Derating Curve vs Junction Temperature



Avalanche Energy : E_{AS} / E_{AS} max. [%]

Fig.6 Typical Output Characteristics(I)

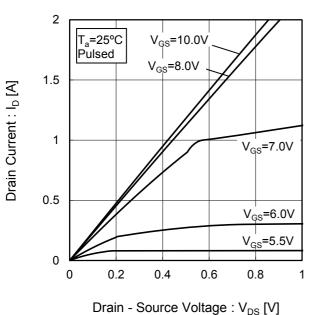
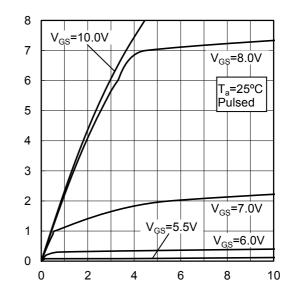


Fig.7 Typical Output Characteristics(II)

Junction Temperature : T_i [°C]



Drain - Source Voltage : V_{DS} [V]

Drain Current : I_D [A]

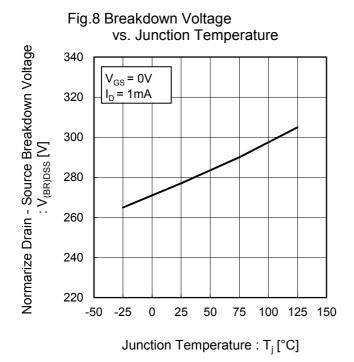
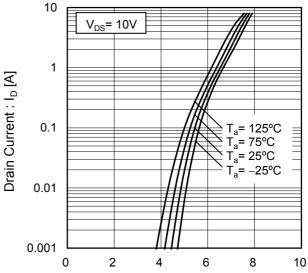


Fig.9 Typical Transfer Characteristics



Gate - Source Voltage : V_{GS} [V]

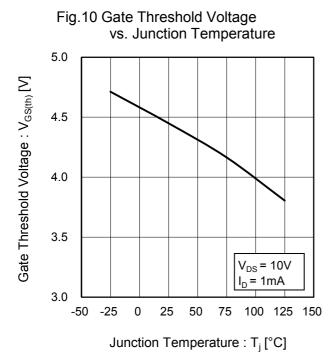
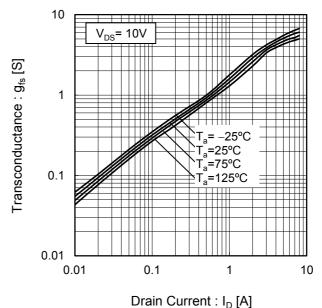


Fig.11 Transconductance vs. Drain Current



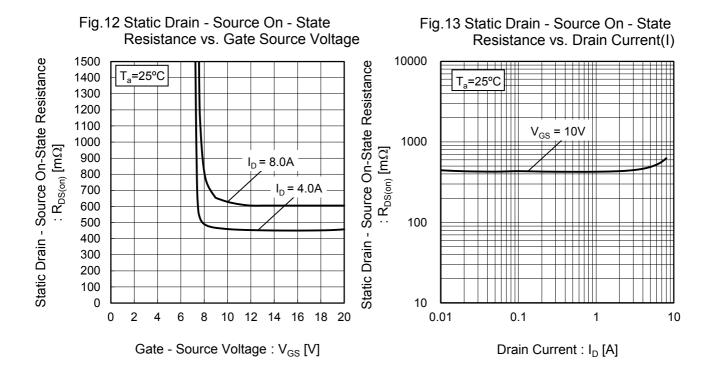


Fig.14 Static Drain - Source On - State
Resistance vs. Junction Temperature

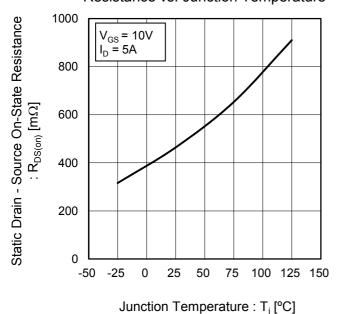


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(I)

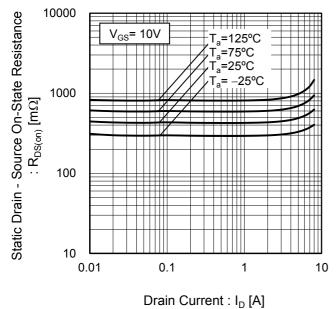
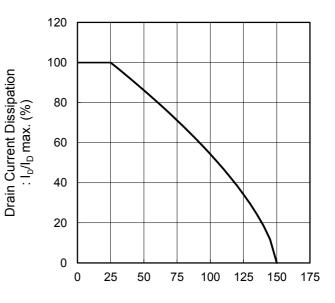
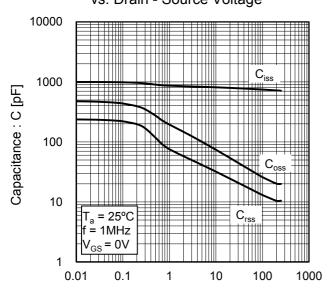


Fig.16 Drain Current Derating Curve



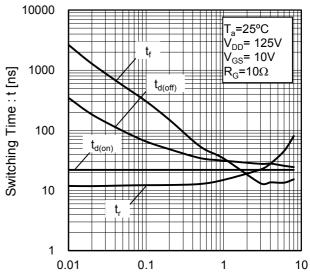
Junction Temperature : T_i [°C]

Fig.17 Typical Capacitance vs. Drain - Source Voltage



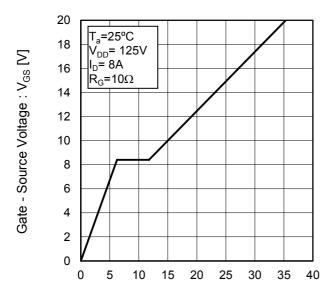
Drain - Source Voltage : V_{DS} [V]

Fig.18 Switching Characteristics

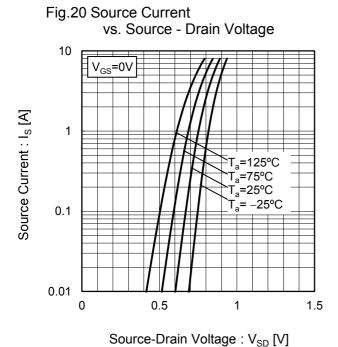


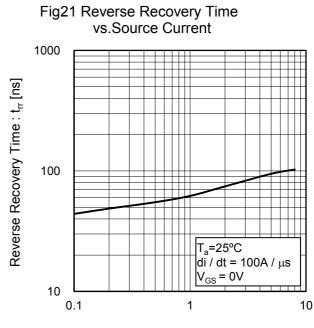
Drain Current : I_D [A]

Fig.19 Dynamic Input Characteristics



Total Gate Charge : Q_g [nC]





Source Current : I_S [A]

●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

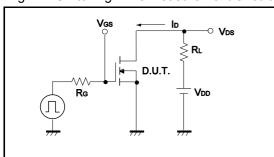


Fig.2-1 Gate Charge Measurement Circuit

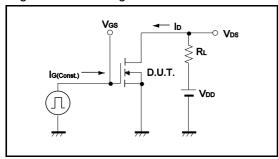


Fig.3-1 Avalanche Measurement Circuit

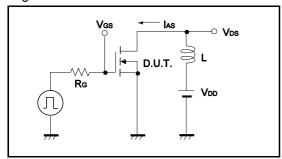


Fig.1-2 Switching Waveforms

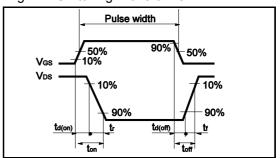


Fig.2-2 Gate Charge Waveform

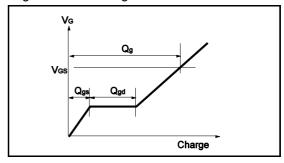
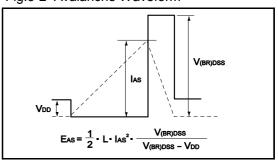
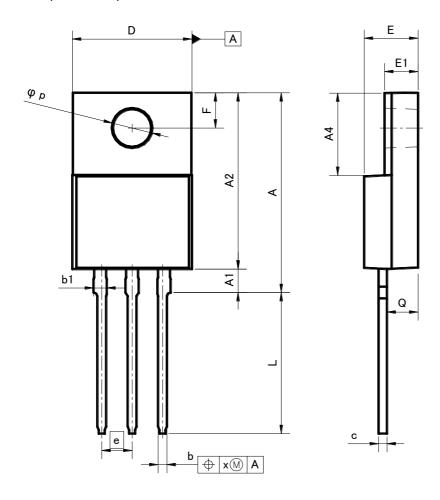


Fig.3-2 Avalanche Waveform



● Bin 228 FMs (Unit: mm)



DIM	MILIMETERS		INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	16.60	17.60	0.654	0.693
A 1	1.80	2.20	0.071	0.087
A2	14.80	15.40	0.583	0.606
A4	6.80	7.20	0.268	0.283
b	0.70	0.85	0.028	0.033
b1	1.10	1.50	0.043	0.059
С	0.70	0.85	0.028	0.033
D	9.90	10.30	0.390	0.406
Е	4.40	4.80	0.173	0.189
е	2.54		0.1	00
E1	2.70	3.00	0.106	0.118
F	2.80	3.20	0.110	0.126
L	11.50	12.50	0.453	0.492
р	3.00	3.40	0.118	0.134
Q	2.10	3.10	0.083	0.122
Х	_	0.38	_	0.015

Dimension in mm / inches

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JÁPAN	USA	EU	CHINA
CLASSⅢ	СГУССШ	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
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- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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